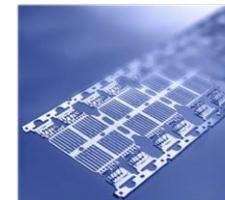
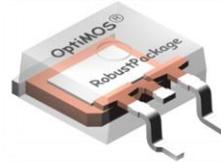


Automotive Power MOSFET

Customer Presentation

January 2017

www.infineon.com/automotivemosfet



Automotive MOSFET

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Infineon and International Rectifier: A Powerful Combination



= A Powerful
Combination



Together
we have an even
larger and **more diverse**
portfolio of
Automotive MOSFET
products
to offer you!

Automotive MOSFETs (Combined IR + IFX) Selection Guide



www.infineon.com/automotivemosfet



Products Applications Tools About

> Products > Power > Power MOSFET > 20V-600V Auto

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Adobe Acrobat Document

20V-600V

Infineon OptiMOS™

We continuously offer the best MOSFET technology,

- Leading $R_{DS(on)}$
- Highest current
- Lowest switch
- Robust package

20V-600V Automotive

> 20V-40V N-Channel

> 100V-300V N-Channel

> 20V-150V P-Channel



Newsletter Contact Where to Buy English ▾ Login ▾

Search



Automotive MOSFET - Product Overview

IR International Rectifier
Automotive Power MOSFETs
See more at IRF.com

MOSFET Finder

Quick Start Features More

Select Breakdown Voltage ▾

Drain Current A

$R_{DS(on)}$ mOhm

Reset Find Parts

Related Links

- New OptiMOS™ 5 40V in S308 Package
- TO-Leadless Package (TOLL)
- Leading and Innovative Semiconductor Solutions for Hybrid and Electric Vehicles
- Small Electric Vehicles MOSFETs

Package Outlines

Automotive MOSFET -
Product Overview



Automotive MOSFET

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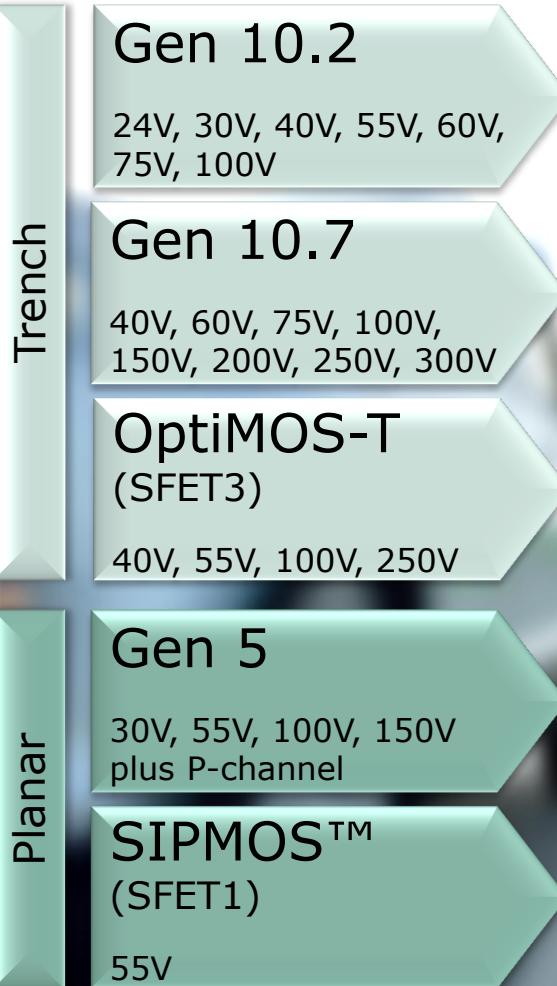
Products

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Process Technology Portfolio and Roadmap

Infineon Technology Leadership in Trench Power MOSFETs



Roadmap
technologies
shown in **Red**.

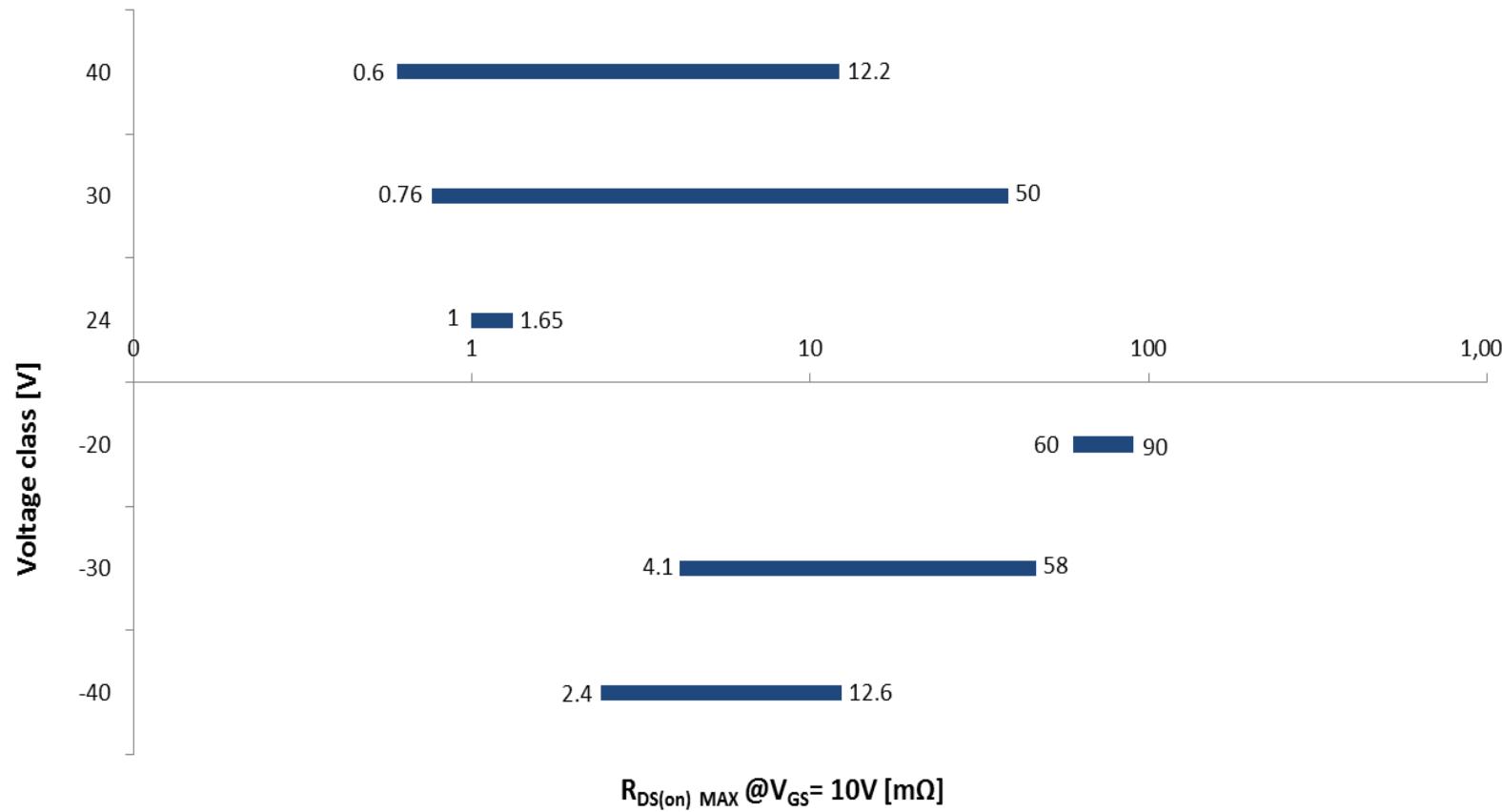
IFX offers planar and trench technologies to address the needs of the entire Automotive MOSFET Market:

- › SFET2, Gen7, Gen5
- › SFET5, SFET4, Gen12.7, SFET3, Gen10.7, Gen10.2
- ➔ Planar
- ➔ Thermal/Rth driven applications
- ➔ Trench
- ➔ $R_{ds(on)}$ driven applications

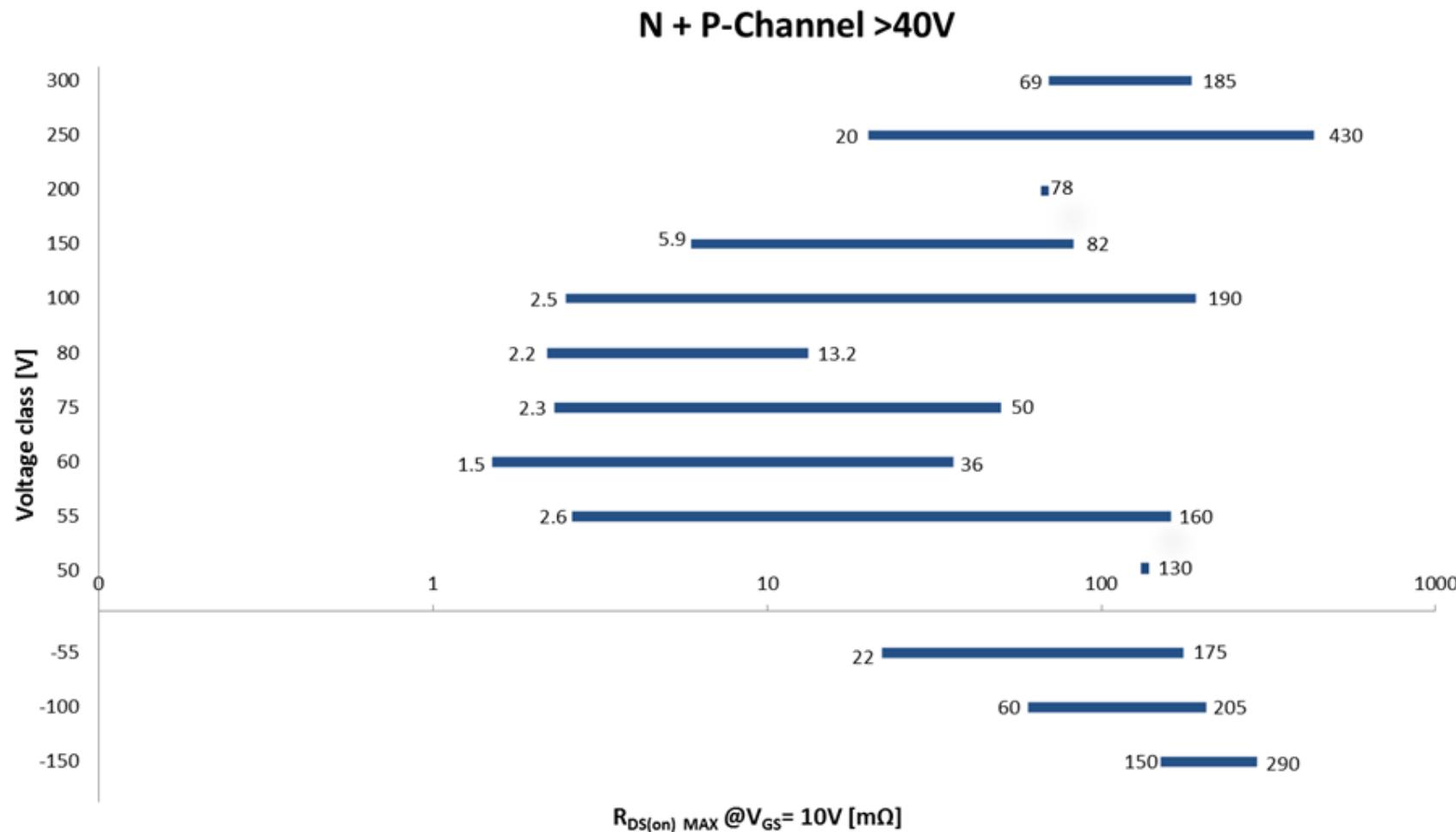
Packages available by voltage class vs. RDS(on) N and P-Channel 20V to 40V



N + P-Channel <= 40V



Packages available by voltage class vs. RDS(on) N and P-Channel 50V to 300V



Infineon Automotive MOSFET Process Technology Roadmap

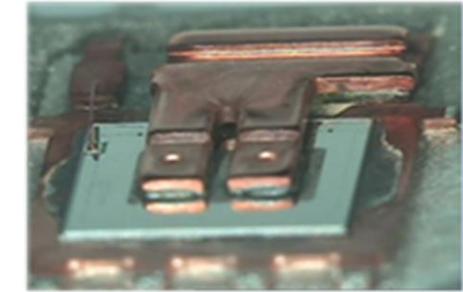
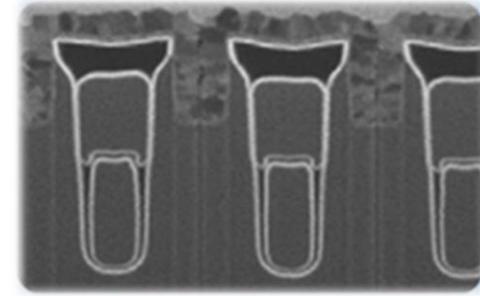


OptiMOS-5 (SFET5)
Infineon's next-generation leading Trench
Technology

Leading OptiMOS-5 MOSFET Trench Technology Features and Customer Benefits



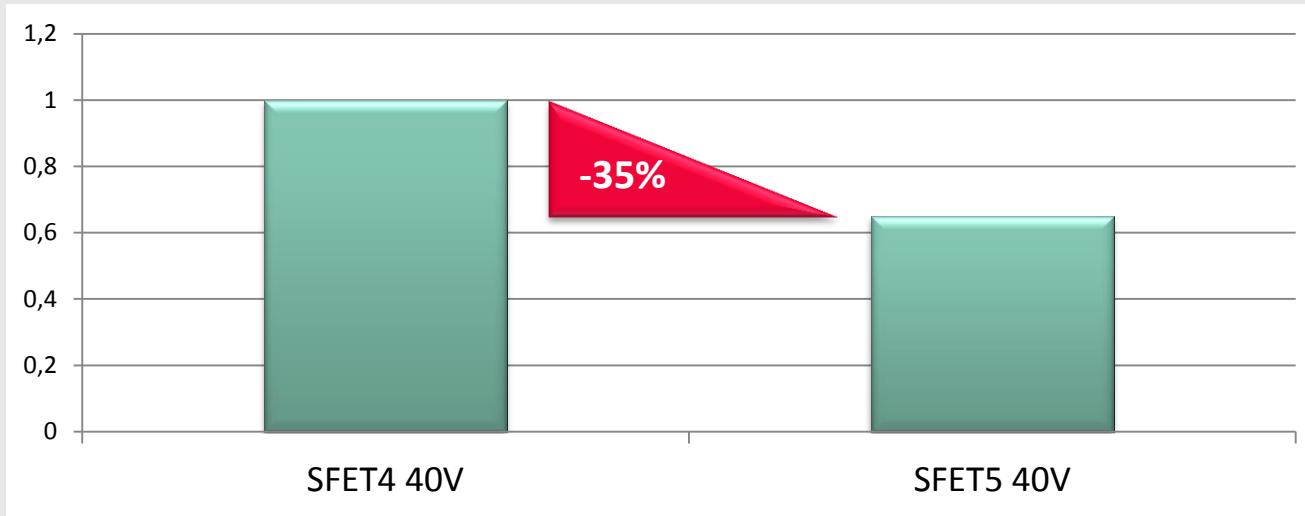
- **Improved $R_{DSon} * Area$**
 - *Leading R_{DSon} and Low conduction losses*
 - *Smaller packages*
- **Improved Switching Parameters**
 - *Reduced C_{iss} & C_{oss}*
 - *Improved switching behavior and EMC*
- **New Top-side Copper-Clip Contact Technology**
 - *Smaller packages for same power*
 - *Lower thermal resistance*
 - *Leading current capability*



An Advantage of OptiMOS™5

Major Improvement in $R_{DS(on)}$ Resistance.

■ Technology Comparison – $R_{DSon} \cdot A$



■ Product Comparison – BIC 40V in SSO8 (5x6)

Parameter	IPC100N04S4-02	IPC100N04S5-1R2	SSO8 S5 40V vs S4 40V
R_{DSon} [mΩ]	2.4	1.2	50% Reduction in Conduction Losses
Q_G [nC]	79	73	Constant Q_G at 50% R_{DSon} Reduction
FOM [nC*mΩ]	190	88	50% Better FOM

Automotive MOSFET

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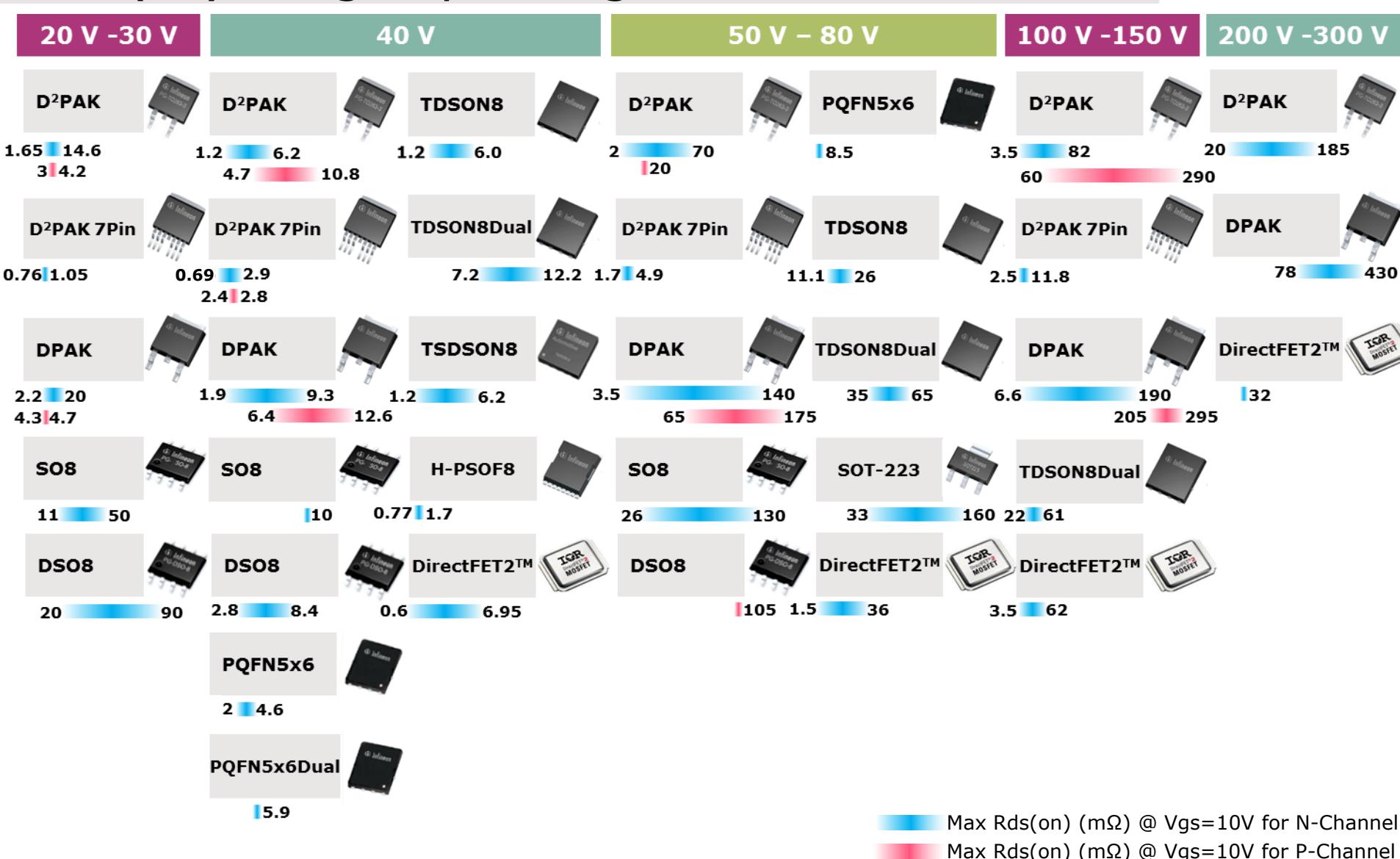
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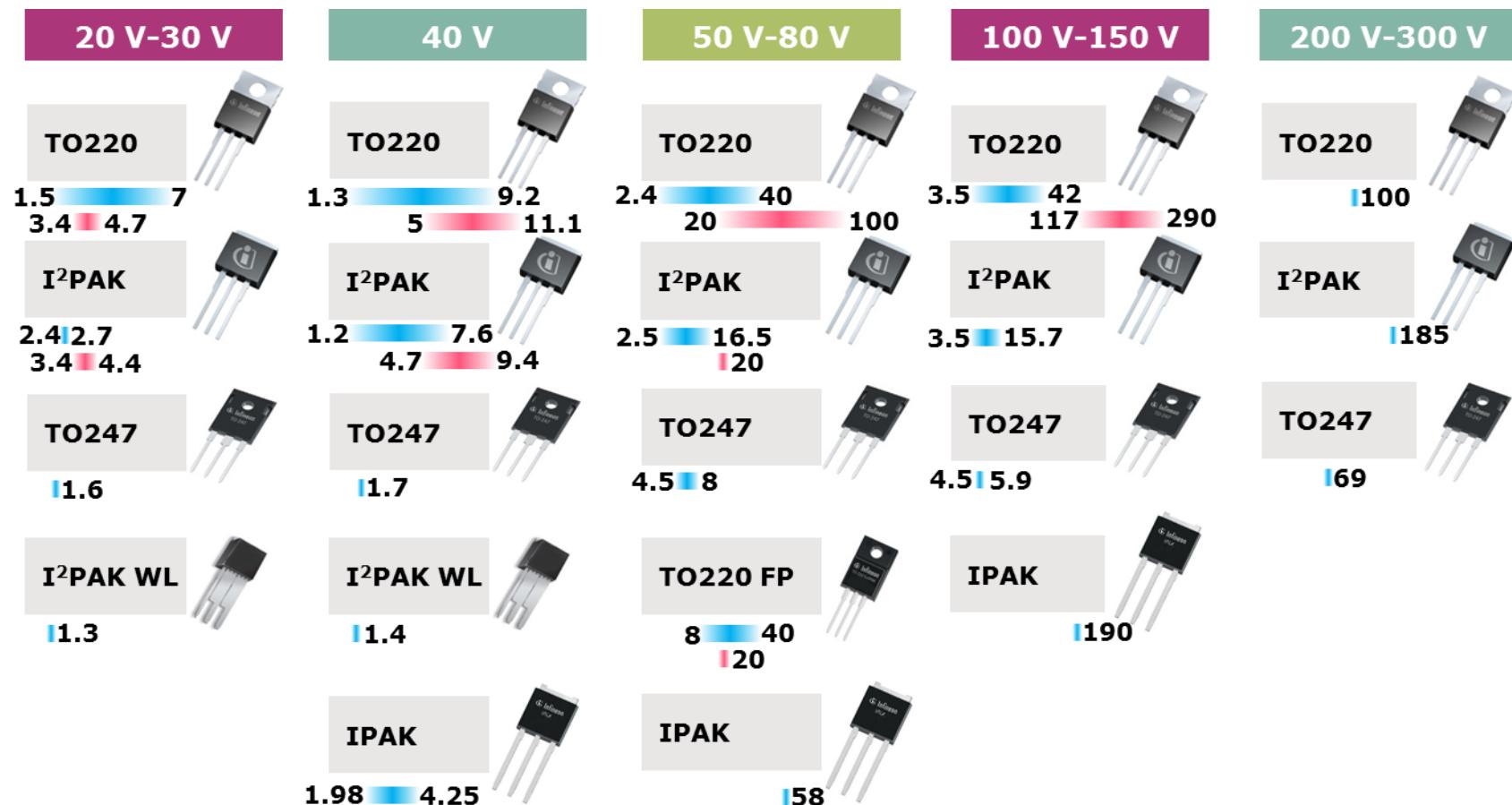
Surface Mount Packages

Rds(on) Range by Voltage Class



Through Hole Packages

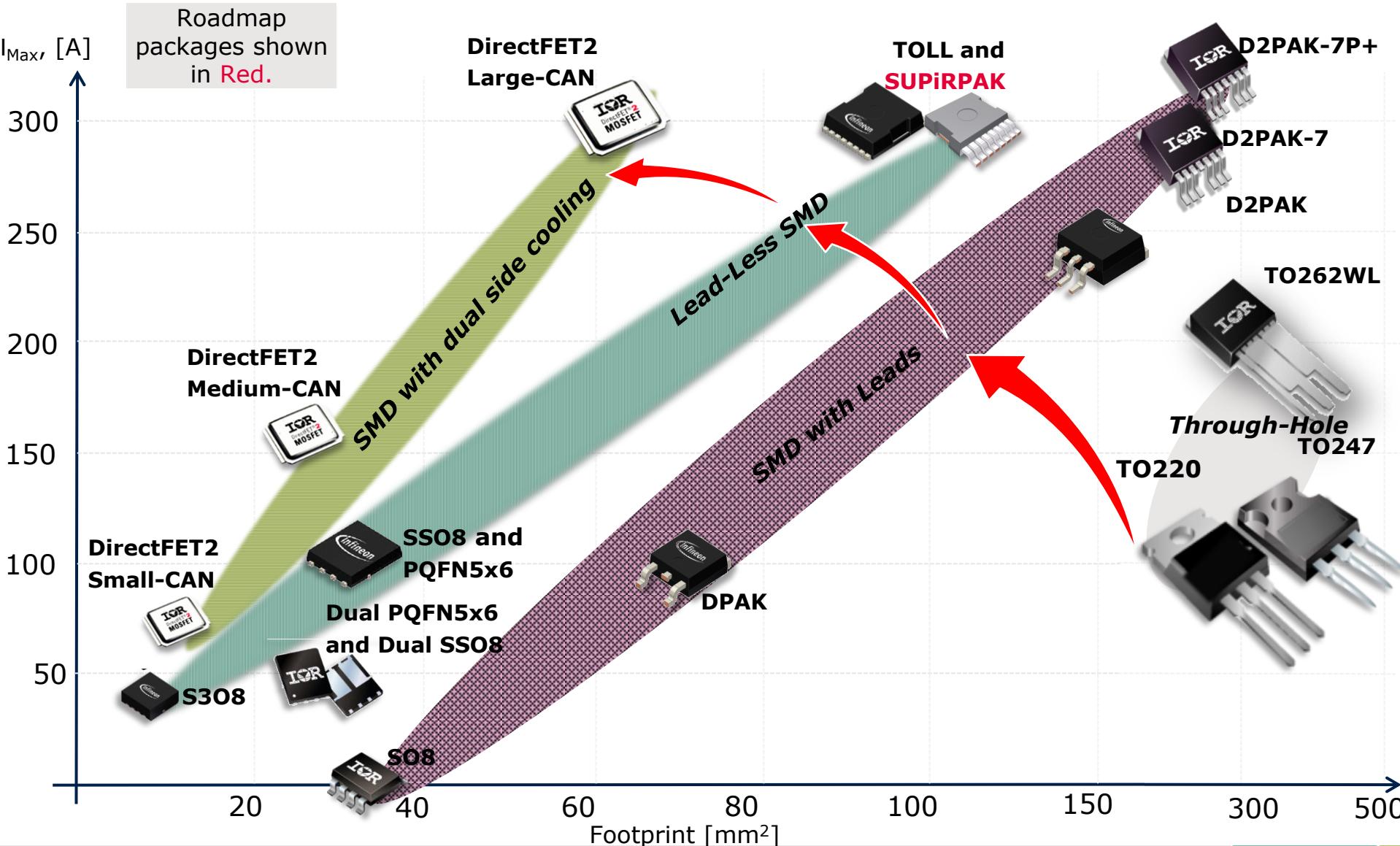
Rds(on) Range by Voltage Class



Max Rds(on) (mΩ) @ Vgs=10V for N-Channel
Max Rds(on) (mΩ) @ Vgs=10V for P-Channel

Package Portfolio and Roadmap

Advancing cooling and miniaturization



Automotive MOSFET Package Development

› Connecting Technologies Improvements

- › Copper clips, ribbon bond, thicker bond wires, diffusion soldering, etc.
- › DirectFET2®, TO-262 WideLead, D2PAK-7P+

› Benefits:

- › Higher current capabilities
- › Better thermal performance
- › 100% Pb free products



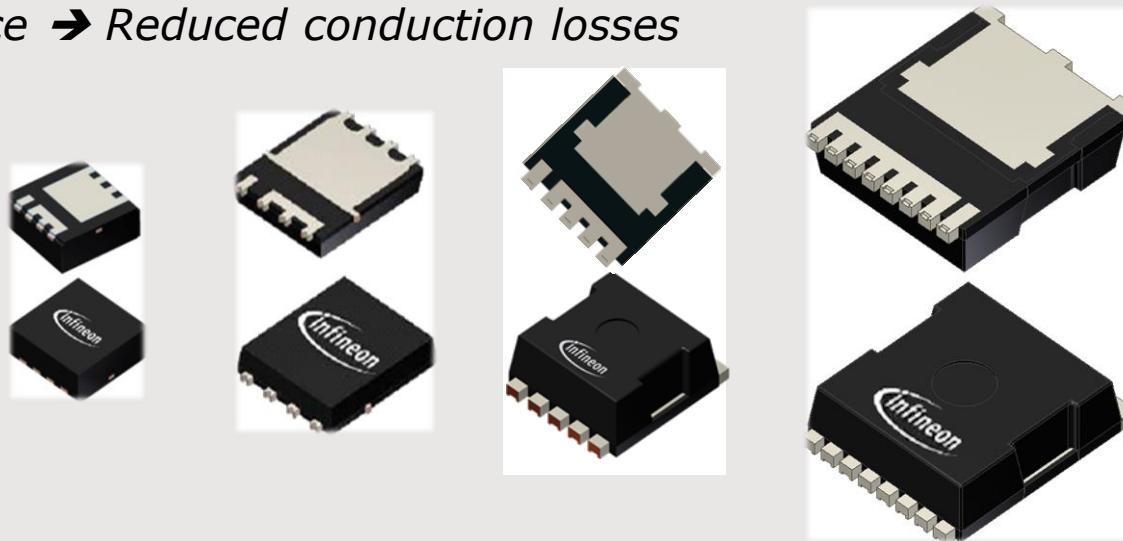
Automotive MOSFET Package Development

› **Development of new Leadless Packages**

- › Shrink Super SO8 (S308)
- › Dual & Single Super SO8 (SS08)/PQFN5x6
- › TOLL (TO-Leadless)
- › SUPiRPAK

› **Features and Benefits:**

- › *Smaller → Less PC Board space required. Possible cost savings.*
- › *Lower Resistance → Reduced conduction losses*



Automotive MOSFET

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Infineon Automotive MOSFET Products

3x3mm Packages
Shrink Super SO8 (S308)

Shrink Super SO8 (S308) Automotive Package 40V Product Portfolio



Sales Name	Technology	max Ron 10V (mΩ)	ID (A)	LL/NL
IPZ40N04S5L-2R8	OptiMOS-5 40V	2.8	40	LL
IPZ40N04S5-3R1	OptiMOS-5 40V	3.1	40	NL
IPZ40N04S5L-4R8	OptiMOS-5 40V	4.8	40	LL
IPZ40N04S5-5R4	OptiMOS-5 40V	5.4	40	NL
IPZ40N04S5L-7R4	OptiMOS-5 40V	7.4	40	LL
IPZ40N04S5-8R4	OptiMOS-5 40V	8.4	40	NL

S308
L x W x H
3.3x3.3x1.0mm ³
BiC 40V
2.8mΩ
I _{DC} = 40A
Cu-Clip soldered

- › Only requires one-sixth the PCB area of a DPAK
- › Two devices take less PCB area than one Dual SSO8
- › Uses benchmark OptiMOS-5 technology → Very low R_{DSon}
- › 40A current rating in a very small package
- › **In production now!**

Infineon Automotive MOSFET Products

5x6mm Packages

- › Single Super SO8 (single SS08)
- › PQFN5x6

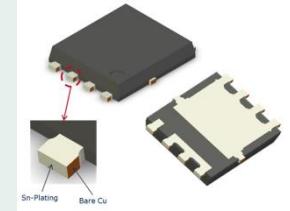
Single Super SO8 Automotive-Qualified Package

40V Next Generation Product Portfolio in OptiMOS-5



Sales Name	max Ron 10V (mOhm)	ID (A)	LL/NL
IPC100N04S5-1R2	1.2	100	NL
IPC100N04S5L-1R1	1.1	100	LL
IPC100N04S5-1R7	1.7	100	NL
IPC100N04S5L-1R5	1.5	100	LL
IPC100N04S5-1R9	1.9	100	NL
IPC100N04S5L-1R9	1.9	100	LL
IPC100N04S5-2R8	2.8	100	NL
IPC100N04S5L-2R6	2.6	100	LL
IPC90N04S5-3R6	3.6	90	NL
IPC90N04S5L-3R3	3.3	90	LL
IPC70N04S5-4R6	4.6	70	NL
IPC70N04S5L-4R2	4.2	70	LL
IPC50N04S5-5R8	5.8	50	NL
IPC50N04S5L-5R5	5.5	50	LL

Single SSO8



L x W x H

6.5x5.1x1.0mm³

BiC 40V

1.2mΩ

50% R_{d(on)} Reduction compared to SFET4 BiC !

I_{DC} = 100A

Cu-Clip soldered

› **Available now!**

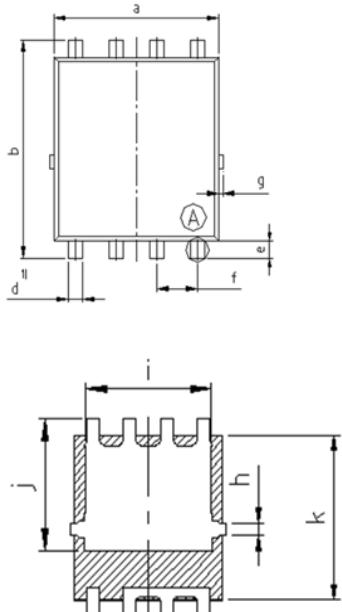
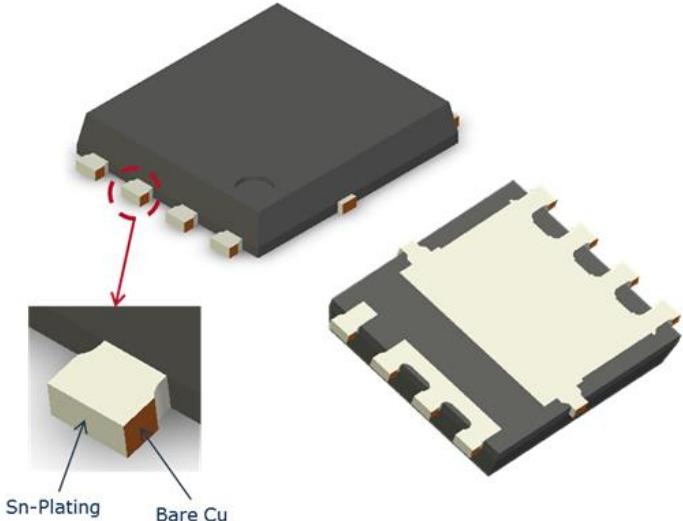
OptiMOS-5 SSO8 Package

Features and Benefits



- › Full 1000 hour life at the max T_j of 175C.
- › New lead-frame for better AOI feature. Complete front surface of the lead has tin plating.
- › No Source bond wires, but Cu clip connection for better resistance and thermal performance
- › Fused Source connection for better current density than competitors with only three isolated Source pins
- › Can replace a DPAK and Save half of the PCB area

OptiMOS-5 SSO8 Package Detail



Characteristic		Target nominal dimension (mm)
Package X	a	5.15
Package Y	b	6.44
Package thickness	c	1.00
Lead width	d	0.44
Lead length	e	0.48
Lead pitch	f	1.27
Fish tail length	g	0.13
Fish tail width	h	0.40
Heat sink X	i	4.30
Heat sink Y	j	4.30
Molded Body	k	5.48

PQFN56 Automotive-Qualified High Voltage MOSFET Portfolio



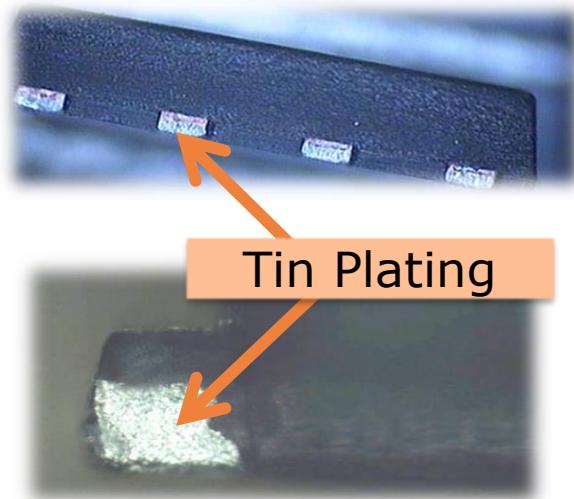
Device	V _{ds} (V)	Technology	max R _{on} (mΩ)	I _D (A)	Package	LL/NL
AUIRFN7107TR	75	Gen10.7	8.5	76	PQFN56	NL
AUIRFN7110TR	100	Gen10.7	14.5	58	PQFN56	NL

- › Can replace a DPAK in only half the PCB area
- › Low R_{DSon} → low conduction losses
- › **In production now!**

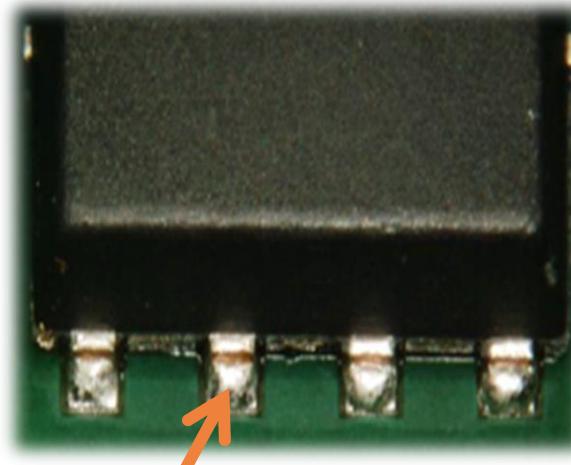


PQFN56 Leadless Package Extended Lead with End Lead Plating

Side View



Solderability Testing Results



End Lead Plating Ensures
Good Solderability

AOI - Inspectable Solder
Joint

Good Solder Cover
Range at End Lead

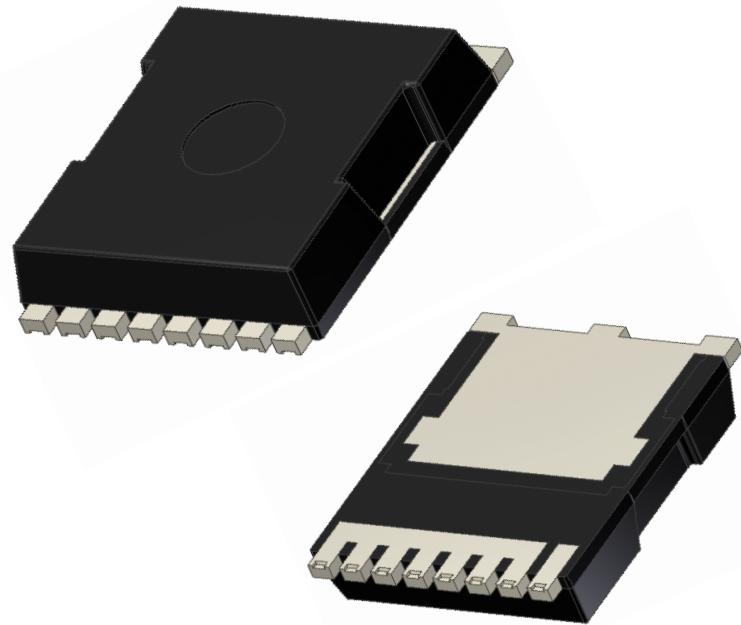
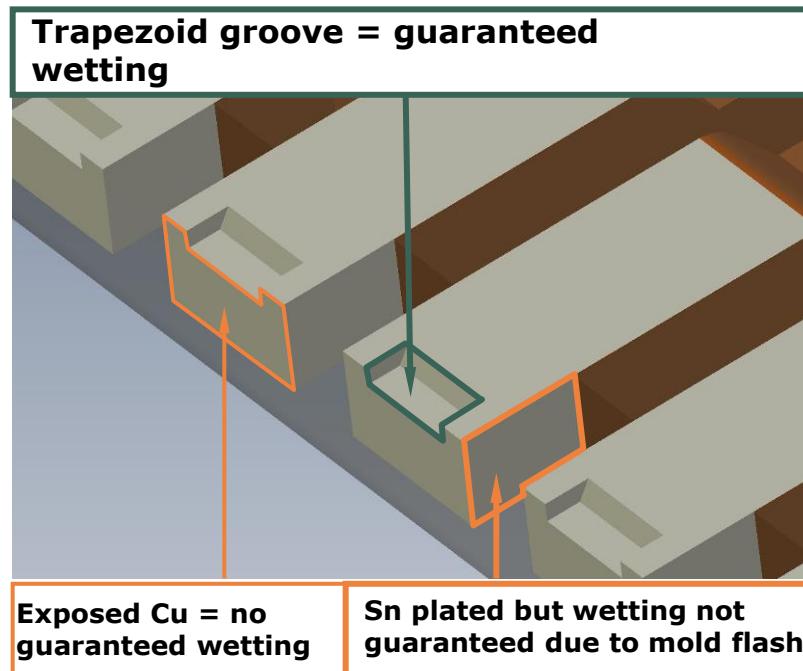
Solder Across the Lead
from Side to Side

Infineon Automotive MOSFET Products

TOLL (TO Lead-Less) package
products

TO-Leadless Package Features

- › *30% less board space compared with D²PAK*
- › Reduced package electrical and thermal resistance
- › Lower lead inductances for optimized switching performance
- › *Compatible with AOI at your manufacturing site*



OPTIMOS-T2 40V TOLL Automotive Product Portfolio

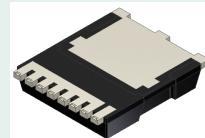


› 40V Product Family

Product Name	Technology	max Ron 10V (mΩ)	ID (A)	LL/NL	SOP
IPLU300N04S4-R8	OptiMOS-T2 40V	0.77	300	NL	released
IPLU300N04S4-1R1	OptiMOS-T2 40V	1.1	300	NL	released
IPLU250N04S4-1R7	OptiMOS-T2 40V	1.7	250	NL	released

› ***In production now!***

TOLL



L x W x H

11.7x9.9x2.3mm

BiC 40V

0.77mΩ

I_{DC} = 300A

Al-bond wire

NEW OPTIMOS-5 80V TOLL Automotive Product Portfolio



Device	Technology	max Ron (mOhm)	ID (A)	Package	LL/NL
IAUT300N08S5N012	OptiMOS 5 80V	1.2mOhm	300	TOLL	NL
IAUT165N08S5N029	OptiMOS 5 80V	2.9mOhm	165	TOLL	NL

› **Available now!**

TOLL



L x W x H
11.7x9.9x2.3mm

**BIC 80V
1.2mΩ**

$I_{DC} = 300A$

Al bond wire

NEW OPTIMOS-5 100V TOLL Automotive Product Portfolio



Device	Technology	max Ron (mOhm)	ID (A)	Package	LL/NL
IAUT300N10S5N015	OptiMOS 5 100V	1.50	300	TOLL	NL
IAUT150N10S5N035	OptiMOS 5 100V	3.50	150	TOLL	NL

SFET5 100V TOLL	Project schedule
Deliverable	
ES	Available
QS	Q3 2017
SOP	Q1 2018

TOLL



L x W x H
11.7x9.9x2.3mm

BIC 100V
1.5mΩ

$I_{DC} = 300A$

Al bond wire

Preliminary Information. Subject to change.

* Please contact Product Marketing if you require urgent sampling support

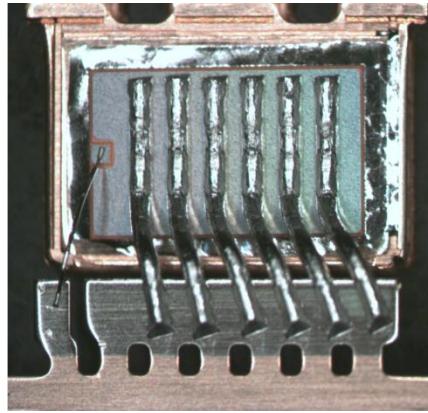
Infineon Automotive MOSFET Products

D2PAK-7P+ package
products

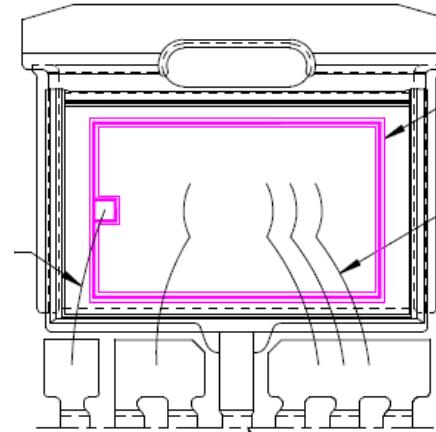
NEW! D2PAK-7P+ Package Feature

Same Footprint, 50% More Current!

D2PAK-7P+



D2PAK-7P



**Maximum
6 x 500 μ m Wire**

360A

**Maximum
4 x 500 μ m Wire**

240A

Footprint 100% Compatible

D2PAK-7P+ 40V Product Portfolio

Device	Technology	max Ron (mΩ)	ID (A)	Package	LL/NL
AUIRFS A 8409-7P	Gen12.7 40V	0.69	360	D2PAK-7P+	NL
In Production Now!					

Same D2PAK-7P footprint

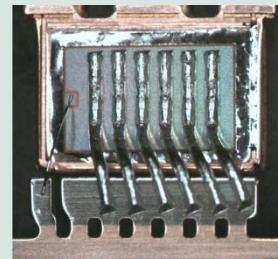
Drop in replacement

Up to 360A current

Improved power density

Benchmark R_{ds(on)}

D2PAK-7P+



L x W x H
15.2.7x10.2x4.4mm
(Same as D2PAk-7P)

Product Datasheet
available online:

<http://www.irf.com/product-info/datasheets/data/auirfsa8409-7p.pdf>

Targeted Applications

- Battery Switch
- Reverse Battery Protection
- EPS Phase Switch

BIC 40V
0.69mΩ

I_{DC} = **360A**

Al bond wire

Infineon Automotive MOSFET Products

Dual Super SO8 (Dual SS08)

Dual Super-SO8/PQFN56 Product Family

Planar & Trench, 40V/60V/100V Products

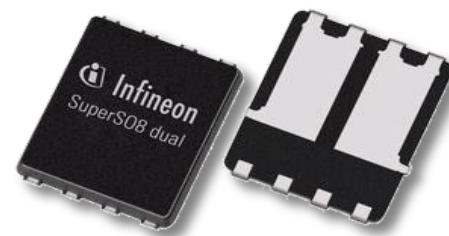


› Can replace two DPAKs while taking 75% less PCB area

OptiMOS Dual SSO8	Technology	max Ron 10V (mOhm) / channel	ID (A) / channel	max R _{thJC} [K/W]	LL/NL	Package
AUIRFN8459	Gen12.7 40V	5.9	50	3.0	NL	PQFN56 Dual
IPG20N04S4L-07A	OptiMOS-T2 40V	7.2	20	2.3	LL	PG-TDSON-8-10
IPG20N04S4-08A	OptiMOS-T2 40V	7.6	20	2.3	NL	PG-TDSON-8-10
IPG20N04S4L-08A	OptiMOS-T2 40V	8.2	20	2.8	LL	PG-TDSON-8-10
IPG20N04S4L-11A	OptiMOS-T2 40V	11.6	20	3.7	LL	PG-TDSON-8-10
IPG20N04S4-12A	OptiMOS-T2 40V	12.2	20	3.7	NL	PG-TDSON-8-10
IPG20N06S4L-11A	OptiMOS-T2 60V	11.2	20	2.3	LL	PG-TDSON-8-10
IPG20N06S4L-14A	OptiMOS-T2 60V	13.7	20	3.0	LL	PG-TDSON-8-10
IPG20N06S4-15A	OptiMOS-T2 60V	15.5	20	3.0	NL	PG-TDSON-8-10
IPG20N06S4L-26A	OptiMOS-T2 60V	26.0	20	4.5	LL	PG-TDSON-8-10
IPG20N06S2L-35A	OptiMOS 55V	35.0	20	2.3	LL	PG-TDSON-8-10
IPG20N06S2L-50A	OptiMOS 55V	50.0	20	2.9	LL	PG-TDSON-8-10
IPG20N06S2L-65A	OptiMOS 55V	65.0	20	3.5	LL	PG-TDSON-8-10
IPG20N10S4L-22A	OptiMOS-T2 100V	22.0	20	2.2	LL	PG-TDSON-8-10
IPG20N10S4L-35A	OptiMOS-T2 100V	35.0	20	3.2	LL	PG-TDSON-8-10
IPG20N10S4-36A	OptiMOS-T2 100V	35.0	20	3.2	NL	PG-TDSON-8-10
IPG16N10S4-61A	OptiMOS-T2 100V	61.0	16	4.8	NL	PG-TDSON-8-10
IPG16N10S4L-61A	OptiMOS-T2 100V	61.0	16	5.2	LL	PG-TDSON-8-10

› **Front-end technology options:**

- OptiMOS™ 55V: Thermal driven applications
- OptiMOS™-T2 40V: R_{DSon} driven applications
- Gen12.7 40V: R_{DSon} driven applications
- OptiMOS™-T2 60V: R_{DSon} driven applications
- OptiMOS™-T2 100V: R_{DSon} driven applications
- AOI-compatible leads (a.k.a. wettable flanks)
- Standard leads w/o AOI at lower price



Infineon Automotive MOSFET Products

DirectFET²® -
Increase System Efficiency and Power Density



DirectFET²[®] - Improve System Efficiency, Reliability and Power Density



Very Small Package Size and Height

Lowest Package Resistance and Inductance

Lowest Top-Side Thermal Impedance

No Lead Frame, Wire Bond, or Molding

100%  Solution to Address



Increased System Efficiency

Increased power Density

Reduced Parasitic Ringing

DirectFET²® Success Story

End Car Manufacturer:

Major OEM

Production Date:

2015

More System Information:

[Link](#)

Application:

Adaptive Steering System



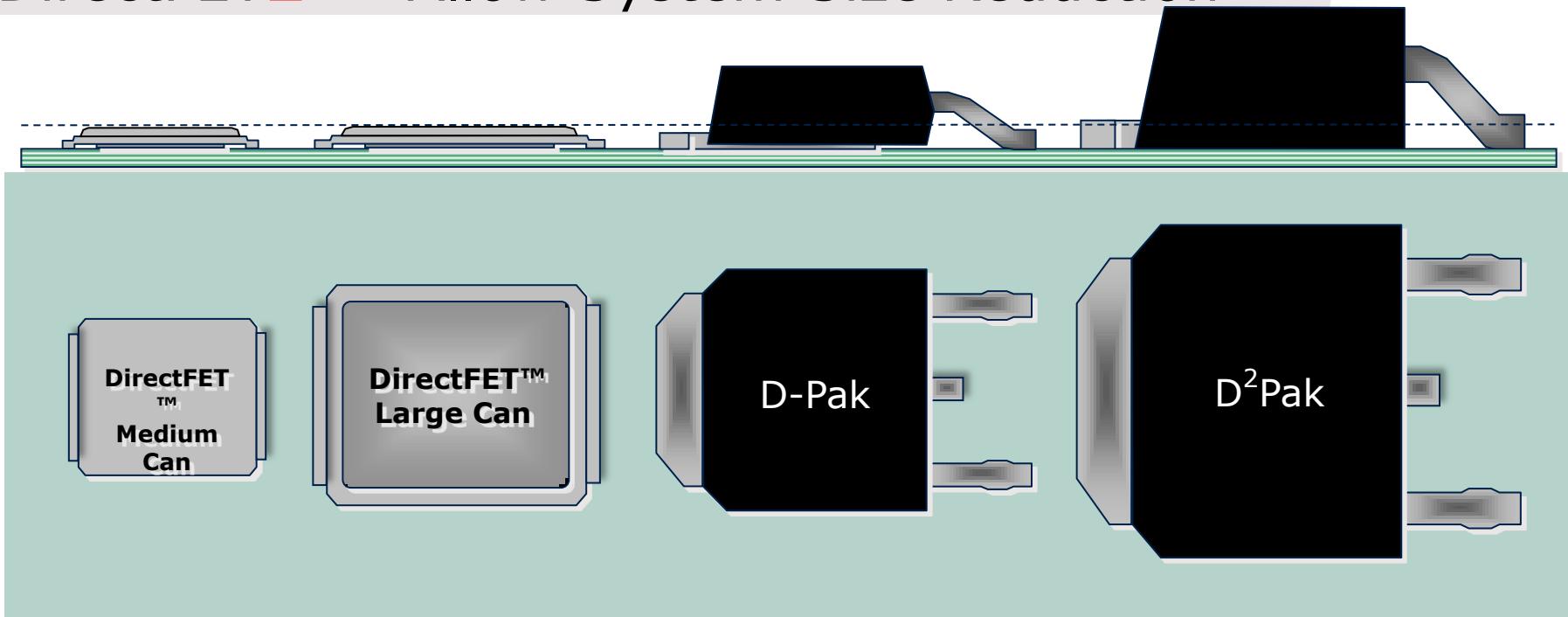
Part Numbers:

40V 3mOhm Medium-Can AU1RF7736M2
(6 per board)

Key Factors for Design Win:

- ✓ Good reliability, ideal for automotive applications
- ✓ Small footprint - DirectFET² Medium Can is 54% smaller than DPAK
- ✓ Better thermal performance vs. conventional packages

DirectFET²[®] - Allow System Size Reduction

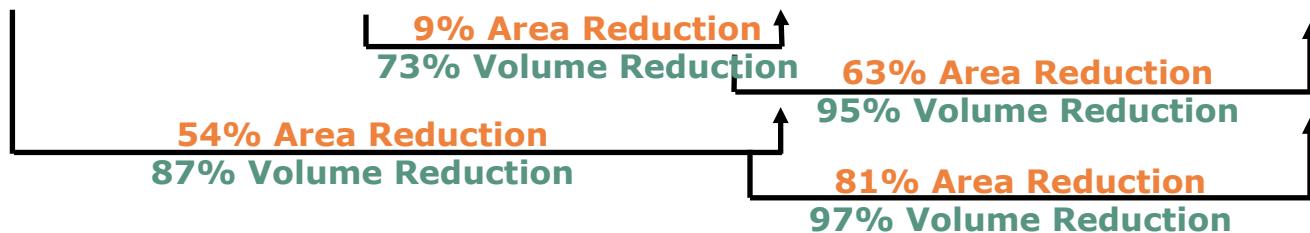


$5.05 \times 6.35 \times$
 0.70
 (0.085 grams)
 32.1mm^2
 22.4mm^3

$7.00 \times 9.10 \times$
 0.70
 (0.178 Grams)
 63.7mm^2
 44.6mm^3

$6.73 \times 10.4 \times 2.38$
 (0.325 grams)
 70.1mm^2
 166mm^3

$10.7 \times 15.9 \times 4.83$
 (1.26 grams)
 170mm^2
 822mm^3



DirectFET²[®] Released Portfolios

Part numbers	Voltage (V)	max Ron 10V (mOhm)	QG typ (nC)	ID (A)	Package	NL/LL	Optimized Feature
AUIRF8739L2	40	0.6	362	309	Large Can - L8	NL	Low Rds(on)
AUIRF7739L2	40	1.0	220	270	Large Can - L8	NL	Low Rds(on)
AUIRF7738L2	40	1.6	147	210	Large Can - L6	NL	Low Rds(on)
AUIRF8736M2	40	1.9	136	137	Medium Can - M4	NL	Low Rds(on)
AUIRF7737L2	40	1.9	89	156	Large Can - L6	NL	Low Rds(on)
AUIRF7736M2	40	3.0	72	108	Medium Can - M4	NL	Low Rds(on)
AUIRL7736M2	40	3.0	59	143	Medium Can - M4	LL	Low Rds(on)
AUIRF7734M2	40	4.9	48	72	Medium Can - M2	NL	Low Rds(on)
AUIRL7732S2	40	6.6	24	65	Small Can - SC	LL	Low Rds(on)
AUIRF7732S2	40	7.0	30	55	Small Can - SC	NL	Low Rds(on)
AUIRF7749L2	60	1.6	200	200	Large Can - L8	NL	Low Rds(on)
AUIRF7648M2	60	7.0	35	68	Medium Can - M4	NL	Low Qg
AUIRF7640S2	60	36.0	7	21	Small Can - SB	NL	Low Qg
AUIRF7759L2	75	2.3	200	160	Large Can - L8	NL	Low Rds(on)
AUIRF7769L2	100	3.5	200	124	Large Can - L8	NL	Low Rds(on)
AUIRF7669L2	100	4.4	81	114	Large Can - L8	NL	Low Qg
AUIRL7766M2	100	10.0	44	51	Medium Can - M4	LL	Low Rds(on)
AUIRF7647S2	100	31.0	14	24	Small Can - SC	NL	Low Qg
AUIRF7665S2	100	62.0	8	14	Small Can - SB	NL	Low Qg
AUIRF7675M2	150	56.0	21	18	Medium Can - M2	NL	Low Qg
AUIRF7799L2	250	32.0	110	35	Large Can - L8	NL	Low Rds(on)



Automotive MOSFET

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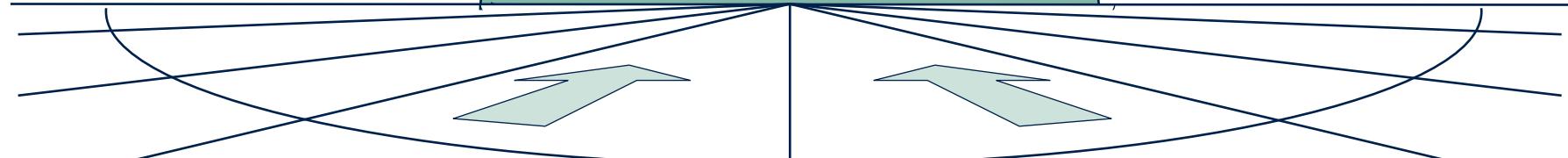
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Conclusion

Infineon Automotive Power MOSFET Conclusion



Vision: Your preferred automotive MOSFET supplier



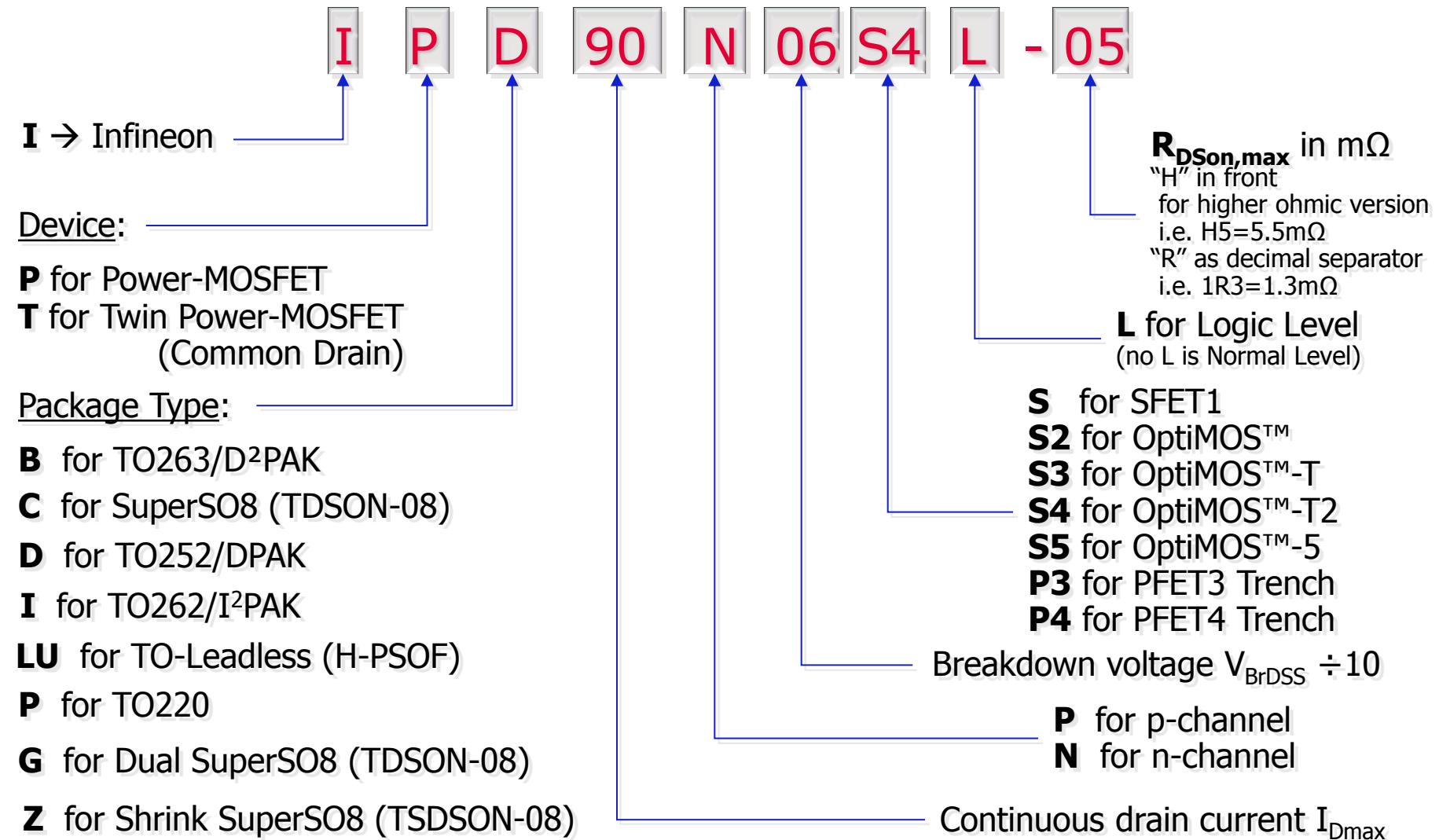
Our leading market position today

- › Benchmark OptiMOS™-5 trench technology: $R_{ds(on)} < 1\text{m}\Omega$. *Better energy efficiency & potential space savings*
- › Excellent *Application Engineering support for your R&D*
- › Zero Defect program: *Quality focus. Lower total costs.*
- › Broad portfolio of automotive qualified devices
 - Planar and trench technology devices
 - N- and P-channel MOSFET devices
 - Standard and new innovative packages
 - Products available from 24V to 300V
 - The best from IR and Infineon brought together
 - *Hundreds of part numbers to choose for your design*
- › Leadership on legal/green requirements: offering the first 100% Pb-free devices. *Supporting your future needs.*

Our plans to support you in the future

- › Focus on new packages
 - Integration – *Space savings (PCB area/cost)*
 - Smaller packages – *Space savings*
 - High current devices – *Capability to drive larger loads. Savings potential by eliminating parallel devices.*
- › Next OptiMOS™-5 trench technology
 - *even better performance for conduction energy efficiency & improved EMC switching behavior*
 - *enables innovative packages*
- › Latest product information & support on our homepage: **www.infineon.com/automotivemosfet**

Automotive MOSFET Naming System



Former IRF Gen12.7 COOLiRFET™ Naming System



AUIRFS8409 xxx

Automotive Grade

AEC-Q101

IR HEXFET

IRF → Standard gate

IRL → Logic Level gate

Package Type

S = D2PAK

S-7P = D2PAK-7P

SL = TO-262

WL (suffix) = TO262 Wide Lead

B = TO-220

N = PQFN

R = DPAK

U = TO-252 (IPAK)

C = Die Sale

Product Family

8 → Gen 12.7

Voltage Rating

4 → 40V

Die Size

For Die Sale:

B = Whole Wafer

D = Chip Pack

F = Die on Film

For Packaging Options:

KD = Known Good Die in Chip Pack

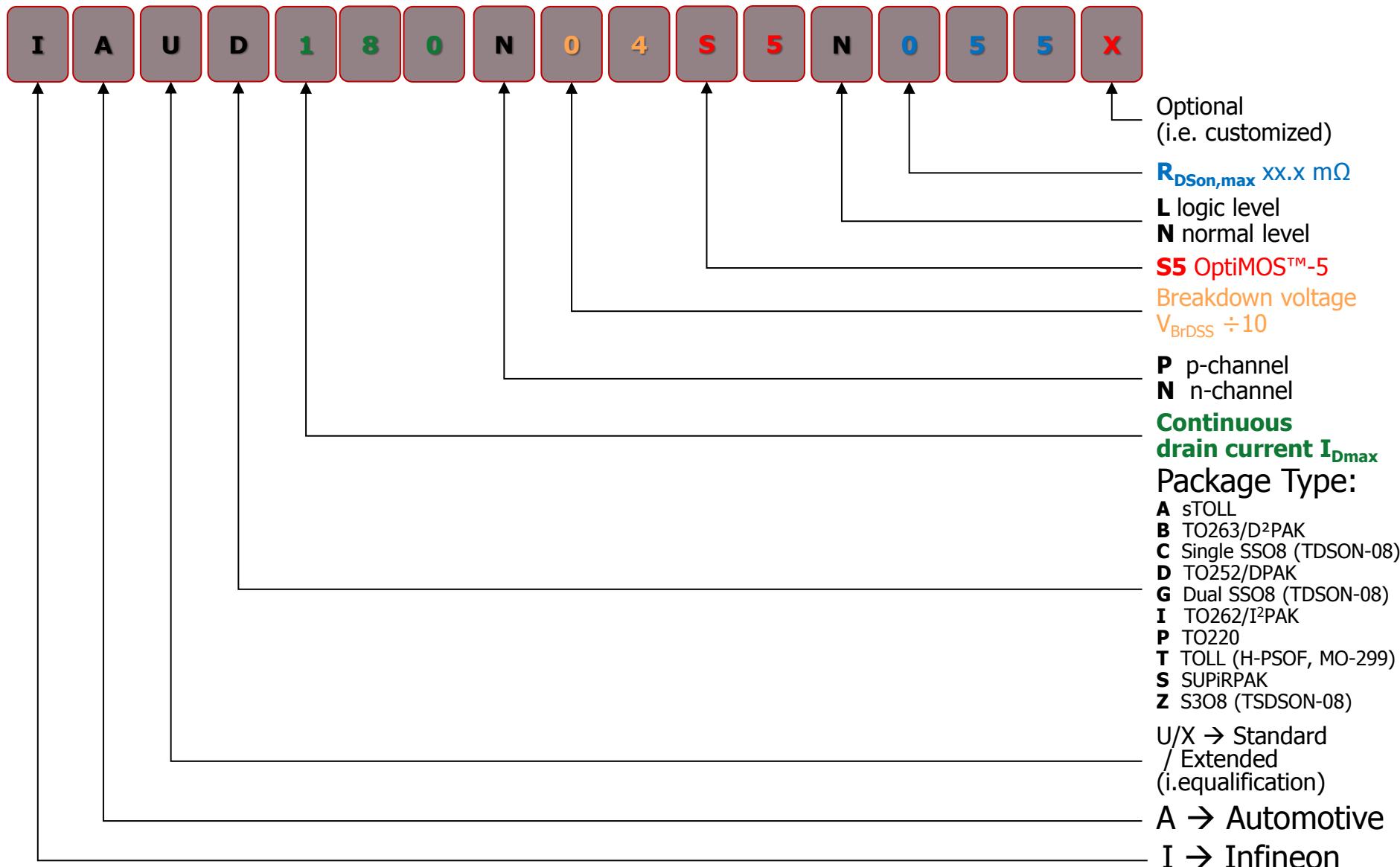
KT = Known Good Die in Tape & Reel

Blank = Tube

TR = Tape & Reel

TR(R,L) = Tape & Reel (Right, Left)

Future Automotive MOSFET Naming System





Part of your life. Part of tomorrow.

